

# BFP842ESD

Robust Low Noise Silicon Germanium Bipolar RF Transistor

## Data Sheet

Revision 1.1, 2013-04-11

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## BFP842ESD, Robust Low Noise Silicon Germanium Bipolar RF Transistor

Revision History: 2013-04-11, Revision 1.1

| Page  | Subjects (major changes since last revision)              |
|-------|-----------------------------------------------------------|
|       | This data sheet replaces the revision from 2012-08-03.    |
| P. 8  | Item about AEC-Q101 added to feature list, minor changes. |
| P. 27 | Picture for marking description updated.                  |
|       |                                                           |
|       |                                                           |

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## 1 Product Brief

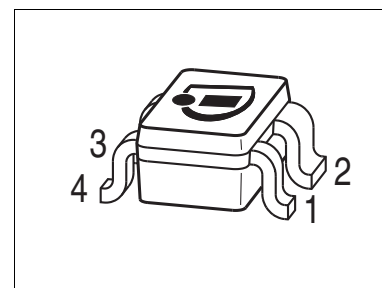
The BFP842ESD is a high performance HBT (Heterojunction Bipolar Transistor) specifically designed for 2.3 - 3.5 GHz LNA applications. The device is based upon the reliable high volume SiGe:C technology of Infineon.

The BFP842ESD provides inherently good input power match as well as inherently good noise match between 2.3 and 3.5 GHz. The simultaneous noise and power match without lossy external matching components at the input leads to a low external parts count, to a very good noise figure and to a high transducer gain in the application. Integrated protection elements at in- and output make the device robust against ESD and excessive RF input power.

The device offers its high performance at low current and voltage and is especially well-suited for portable battery-powered applications in which energy efficiency is a key requirement. The device comes in an easy to use industry standard package with visible leads.

## 2 Features

- Robust very low noise amplifier based on Infineon's reliable, high volume SiGe:C technology
- Unique combination of high-end RF performance and robustness: 16 dBm maximum RF input power, 1 kV HBM ESD hardness
- High linearity  $OIP3 = 25.5$  dBm at 3.5 GHz, 2.5 V, 15 mA
- High transition frequency  $f_T = 60$  GHz enables very low noise figure at high frequencies:  $NF_{min} = 0.65$  dB at 3.5 GHz, 2.5 V, 5 mA
- Transducer gain  $|S_{21}|^2 = 16$  dB @ 3.5 GHz, 2.5 V, 15 mA
- Ideal for low voltage applications e.g.  $V_{CC} = 1.8$  V and 2.85 V (3.3 V, 3.6 V requires corresponding collector resistor)
- Low power consumption, ideal for mobile applications
- Easy to use Pb free (RoHS compliant) and halogen free industry standard package with visible leads
- Qualification report according to AEC-Q101 available



SOT343



## Applications

As very low noise amplifier (LNA) in

- Mobile and fixed connectivity applications: WLAN 802.11b/g/n, WiMAX 2.5/3.5 GHz, Bluetooth
- Satellite communication systems: GNSS Navigation systems (GPS, GLONASS, COMPASS/Beidu/Galileo) Satellite radio (SDARs, DAB and C-band LNB) and C-band LNB (1st and 2nd stage LNA)
- Multimedia applications such as mobile/portable TV, Mobile TV, FM Radio
- 3G/4G UMTS/LTE mobile phone applications
- ISM applications like RKE, AMR and Zigbee

As discrete active mixer, buffer amplifier in VCOs

**Attention: ESD (Electrostatic discharge) sensitive device, observe handling precautions**

| Product Name | Package | Pin Configuration |       |       |       | Marking |
|--------------|---------|-------------------|-------|-------|-------|---------|
| BFP842ESD    | SOT343  | 1 = B             | 2 = E | 3 = C | 4 = E | T9s     |

### 3 Maximum Ratings

**Table 3-1 Maximum Ratings at  $T_A = 25\text{ °C}$  (unless otherwise specified)**

| Parameter                               | Symbol     | Values |             | Unit | Note / Test Condition                                                |
|-----------------------------------------|------------|--------|-------------|------|----------------------------------------------------------------------|
|                                         |            | Min.   | Max.        |      |                                                                      |
| Collector emitter voltage               | $V_{CEO}$  | –      | 3.25<br>2.9 | V    | $T_A = 25\text{ °C}$<br>$T_A = -40\text{ °C}$<br>Open base           |
| Collector emitter voltage <sup>1)</sup> | $V_{CES}$  | –      | 3.25<br>2.9 | V    | $T_A = 25\text{ °C}$<br>$T_A = -40\text{ °C}$<br>E-B short circuited |
| Collector base voltage <sup>2)</sup>    | $V_{CBO}$  | –      | 4.1<br>3.5  | V    | $T_A = 25\text{ °C}$<br>$T_A = -40\text{ °C}$<br>Open emitter        |
| Base current                            | $I_B$      | -5     | 3           | mA   |                                                                      |
| Collector current                       | $I_C$      | –      | 40          | mA   |                                                                      |
| RF input power                          | $P_{RFin}$ | –      | 16          | dBm  |                                                                      |
| ESD stress pulse                        | $V_{ESD}$  | -1     | 1           | kV   | HBM, all pins, acc. to JESD22-A114                                   |
| Total power dissipation <sup>3)</sup>   | $P_{tot}$  | –      | 120         | mW   | $T_S \leq 111\text{ °C}$                                             |
| Junction temperature                    | $T_J$      | –      | 150         |      |                                                                      |
| Storage temperature                     | $T_{Stg}$  | -55    | 150         | °C   |                                                                      |

1)  $V_{CES}$  is identical to  $V_{CEO}$  due to design

2)  $V_{CBO}$  is similar to  $V_{CEO}$  due to design

3)  $T_S$  is the soldering point temperature.  $T_S$  is measured on the emitter lead at the soldering point of the pcb.

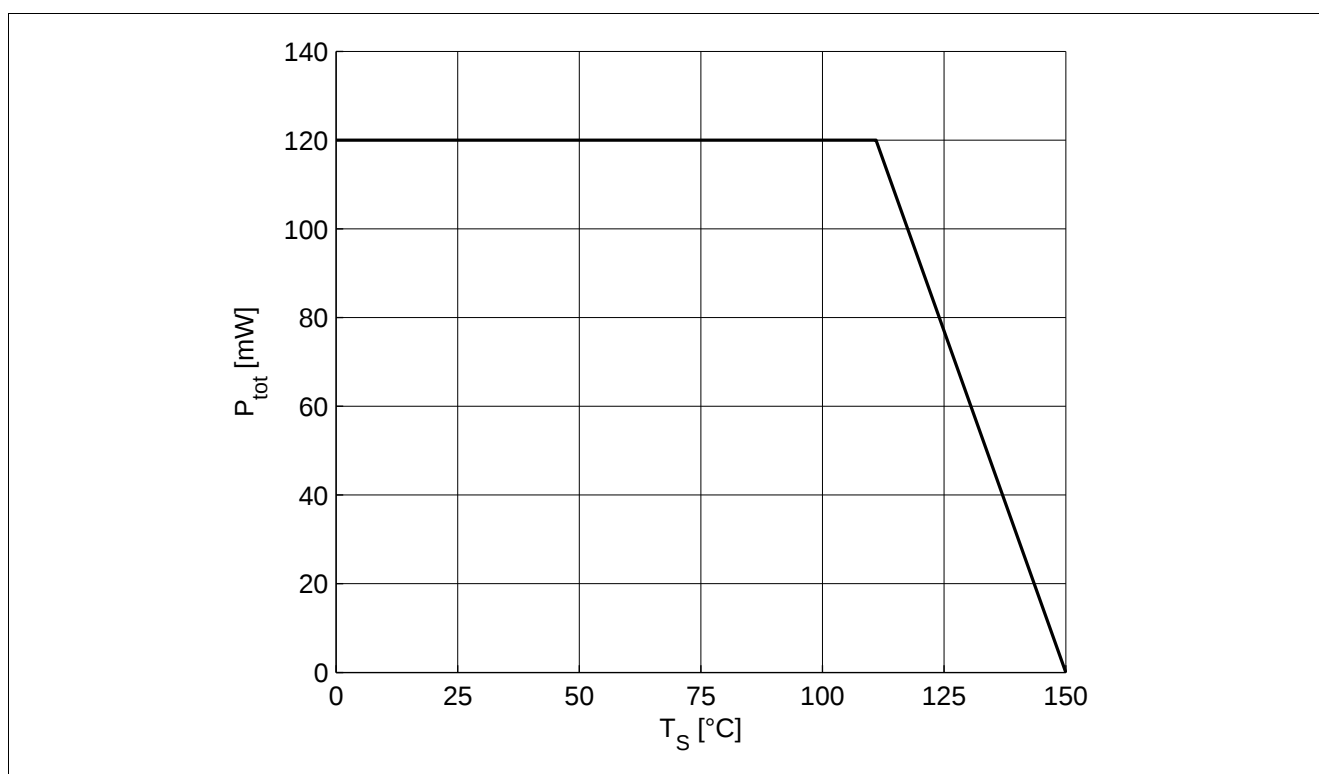
**Attention: Stresses above the max. values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit.**

## 4 Thermal Characteristics

**Table 4-1 Thermal Resistance**

| Parameter                                | Symbol     | Values |      |      | Unit | Note / Test Condition |
|------------------------------------------|------------|--------|------|------|------|-----------------------|
|                                          |            | Min.   | Typ. | Max. |      |                       |
| Junction - soldering point <sup>1)</sup> | $R_{thJS}$ |        | 324  |      | K/W  |                       |

1) For the definition of  $R_{thJS}$  please refer to Application Note AN077 (Thermal Resistance Calculation)


**Figure 4-1 Total Power Dissipation  $P_{tot} = f(T_S)$**

## 5 Electrical Characteristics

### 5.1 DC Characteristics

**Table 5-1 DC Characteristics at  $T_A = 25\text{ °C}$**

| Parameter                           | Symbol        | Values |      |      | Unit          | Note / Test Condition                                            |
|-------------------------------------|---------------|--------|------|------|---------------|------------------------------------------------------------------|
|                                     |               | Min.   | Typ. | Max. |               |                                                                  |
| Collector emitter breakdown voltage | $V_{(BR)CEO}$ | 3.25   | 3.7  |      | V             | $I_C = 1\text{ mA}$ , $I_B = 0$<br>Open base                     |
| Collector emitter leakage current   | $I_{CES}$     |        |      | 400  | nA            | $V_{CE} = 2\text{ V}$ , $V_{BE} = 0$<br>E-B short circuited      |
| Collector base leakage current      | $I_{CBO}$     |        |      | 400  | nA            | $V_{CB} = 2\text{ V}$ , $I_E = 0$<br>Open emitter                |
| Emitter base leakage current        | $I_{EBO}$     |        |      | 10   | $\mu\text{A}$ | $V_{EB} = 0.5\text{ V}$ , $I_C = 0$<br>Open collector            |
| DC current gain                     | $h_{FE}$      | 150    | 260  | 450  |               | $V_{CE} = 2.5\text{ V}$ , $I_C = 15\text{ mA}$<br>Pulse measured |

### 5.2 General AC Characteristics

**Table 5-2 General AC Characteristics at  $T_A = 25\text{ °C}$**

| Parameter                     | Symbol   | Values |      |      | Unit | Note / Test Condition                                                              |
|-------------------------------|----------|--------|------|------|------|------------------------------------------------------------------------------------|
|                               |          | Min.   | Typ. | Max. |      |                                                                                    |
| Transition frequency          | $f_T$    |        | 57   |      | GHz  | $V_{CE} = 2.5\text{ V}$ , $I_C = 25\text{ mA}$<br>$f = 1\text{ GHz}$               |
| Collector base capacitance    | $C_{CB}$ |        | 64   |      | fF   | $V_{CB} = 2\text{ V}$ , $V_{BE} = 0$<br>$f = 1\text{ MHz}$<br>Emitter grounded     |
| Collector emitter capacitance | $C_{CE}$ |        | 0.46 |      | pF   | $V_{CE} = 2\text{ V}$ , $V_{BE} = 0$<br>$f = 1\text{ MHz}$<br>Base grounded        |
| Emitter base capacitance      | $C_{EB}$ |        | 0.44 |      | pF   | $V_{EB} = 0.4\text{ V}$ , $V_{CB} = 0$<br>$f = 1\text{ MHz}$<br>Collector grounded |

### 5.3 Frequency Dependent AC Characteristics

Measurement setup is a test fixture with Bias T's in a 50  $\Omega$  system,  $T_A = 25\text{ }^{\circ}\text{C}$

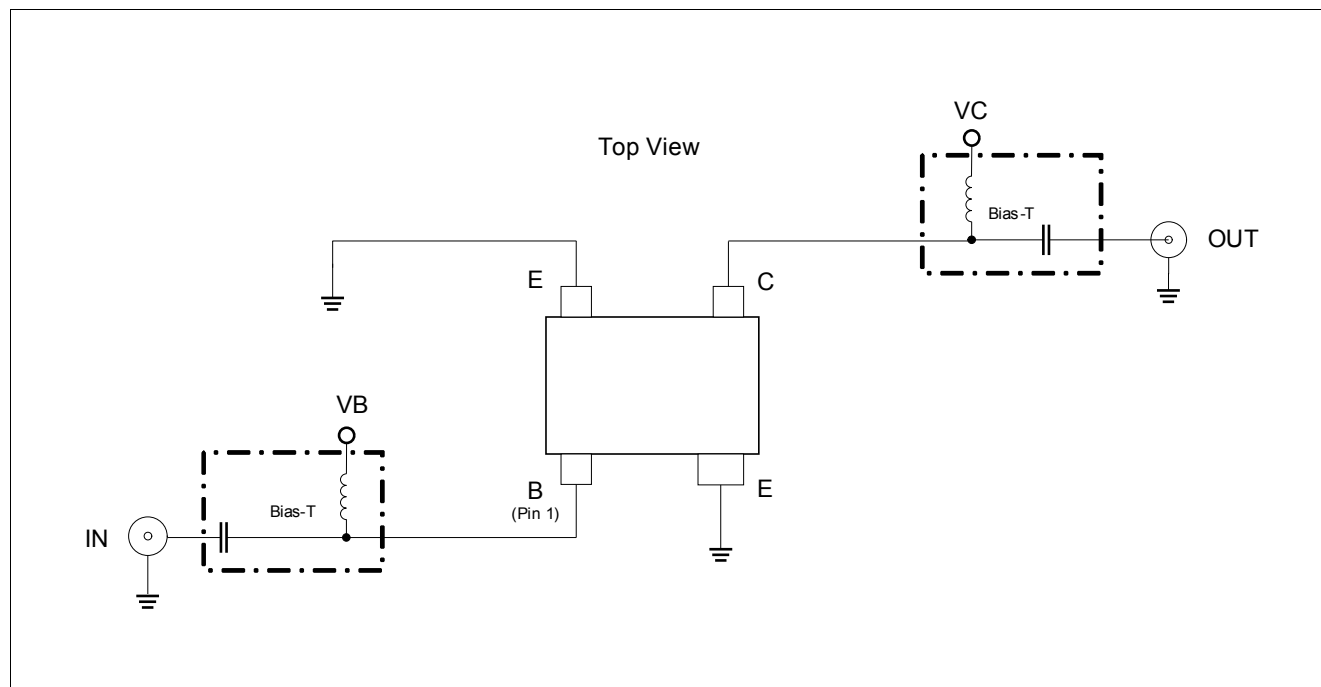


Figure 5-1 BFP842ESD Testing Circuit

Table 5-3 AC Characteristics,  $V_{CE} = 2.5\text{ V}$ ,  $f = 0.45\text{ GHz}$

| Parameter                           | Symbol       | Values |      |      | Unit | Note / Test Condition                                  |
|-------------------------------------|--------------|--------|------|------|------|--------------------------------------------------------|
|                                     |              | Min.   | Typ. | Max. |      |                                                        |
| <b>Power Gain</b>                   |              |        |      |      | dB   |                                                        |
| Maximum power gain                  | $G_{ms}$     | –      | 33   | –    |      | $I_C = 15\text{ mA}$                                   |
| Transducer gain                     | $ S_{21} ^2$ | –      | 29.5 | –    |      | $I_C = 15\text{ mA}$                                   |
| <b>Minimum Noise Figure</b>         |              |        |      |      | dB   |                                                        |
| Minimum noise figure                | $NF_{min}$   | –      | 0.4  | –    |      | $I_C = 5\text{ mA}$                                    |
| Associated gain                     | $G_{ass}$    | –      | 26   | –    |      | $I_C = 5\text{ mA}$                                    |
| <b>Linearity</b>                    |              |        |      |      | dBm  |                                                        |
| 1 dB compression point at output    | $OP_{1dB}$   | –      | 6.5  | –    |      | $Z_S = Z_L = 50\text{ }\Omega$<br>$I_C = 15\text{ mA}$ |
| 3rd order intercept point at output | $OIP3$       | –      | 22   | –    |      | $I_C = 15\text{ mA}$                                   |

## Electrical Characteristics

Table 5-4 AC Characteristics,  $V_{CE} = 2.5 \text{ V}$ ,  $f = 0.9 \text{ GHz}$ 

| Parameter                           | Symbol       | Values |      |      | Unit | Note / Test Condition   |
|-------------------------------------|--------------|--------|------|------|------|-------------------------|
|                                     |              | Min.   | Typ. | Max. |      |                         |
| <b>Power Gain</b>                   |              |        |      |      |      |                         |
| Maximum power gain                  | $G_{ms}$     | –      | 29   | –    | dB   | $I_C = 15 \text{ mA}$   |
| Transducer gain                     | $ S_{21} ^2$ | –      | 26   | –    |      | $I_C = 15 \text{ mA}$   |
| <b>Minimum Noise Figure</b>         |              |        |      |      |      |                         |
| Minimum noise figure                | $NF_{min}$   | –      | 0.45 | –    | dB   | $I_C = 5 \text{ mA}$    |
| Associated gain                     | $G_{ass}$    | –      | 24   | –    |      | $I_C = 5 \text{ mA}$    |
| <b>Linearity</b>                    |              |        |      |      |      |                         |
| 1 dB compression point at output    | $OP_{1dB}$   | –      | 7    | –    | dBm  | $Z_S = Z_L = 50 \Omega$ |
| 3rd order intercept point at output | $OIP3$       | –      | 22.5 | –    |      | $I_C = 15 \text{ mA}$   |

Table 5-5 AC Characteristics,  $V_{CE} = 2.5 \text{ V}$ ,  $f = 1.5 \text{ GHz}$ 

| Parameter                           | Symbol       | Values |      |      | Unit | Note / Test Condition   |
|-------------------------------------|--------------|--------|------|------|------|-------------------------|
|                                     |              | Min.   | Typ. | Max. |      |                         |
| <b>Power Gain</b>                   |              |        |      |      |      |                         |
| Maximum power gain                  | $G_{ms}$     | –      | 25.5 | –    | dB   | $I_C = 15 \text{ mA}$   |
| Transducer gain                     | $ S_{21} ^2$ | –      | 23   | –    |      | $I_C = 15 \text{ mA}$   |
| <b>Minimum Noise Figure</b>         |              |        |      |      |      |                         |
| Minimum noise figure                | $NF_{min}$   | –      | 0.45 | –    | dB   | $I_C = 5 \text{ mA}$    |
| Associated gain                     | $G_{ass}$    | –      | 21   | –    |      | $I_C = 5 \text{ mA}$    |
| <b>Linearity</b>                    |              |        |      |      |      |                         |
| 1 dB compression point at output    | $OP_{1dB}$   | –      | 7.5  | –    | dBm  | $Z_S = Z_L = 50 \Omega$ |
| 3rd order intercept point at output | $OIP3$       | –      | 23.5 | –    |      | $I_C = 15 \text{ mA}$   |

Table 5-6 AC Characteristics,  $V_{CE} = 2.5 \text{ V}$ ,  $f = 1.9 \text{ GHz}$ 

| Parameter                           | Symbol       | Values |      |      | Unit | Note / Test Condition   |
|-------------------------------------|--------------|--------|------|------|------|-------------------------|
|                                     |              | Min.   | Typ. | Max. |      |                         |
| <b>Power Gain</b>                   |              |        |      |      |      |                         |
| Maximum power gain                  | $G_{ms}$     | –      | 23.5 | –    | dB   | $I_C = 15 \text{ mA}$   |
| Transducer gain                     | $ S_{21} ^2$ | –      | 21   | –    |      | $I_C = 15 \text{ mA}$   |
| <b>Minimum Noise Figure</b>         |              |        |      |      |      |                         |
| Minimum noise figure                | $NF_{min}$   | –      | 0.5  | –    | dB   | $I_C = 5 \text{ mA}$    |
| Associated gain                     | $G_{ass}$    | –      | 19.5 | –    |      | $I_C = 5 \text{ mA}$    |
| <b>Linearity</b>                    |              |        |      |      |      |                         |
| 1 dB compression point at output    | $OP_{1dB}$   | –      | 8    | –    | dBm  | $Z_S = Z_L = 50 \Omega$ |
| 3rd order intercept point at output | $OIP3$       | –      | 24.5 | –    |      | $I_C = 15 \text{ mA}$   |

## Electrical Characteristics

Table 5-7 AC Characteristics,  $V_{CE} = 2.5 \text{ V}$ ,  $f = 2.4 \text{ GHz}$ 

| Parameter                           | Symbol       | Values |      |      | Unit | Note / Test Condition   |
|-------------------------------------|--------------|--------|------|------|------|-------------------------|
|                                     |              | Min.   | Typ. | Max. |      |                         |
| <b>Power Gain</b>                   |              |        |      |      |      |                         |
| Maximum power gain                  | $G_{ms}$     | –      | 22   | –    | dB   | $I_C = 15 \text{ mA}$   |
| Transducer gain                     | $ S_{21} ^2$ | –      | 19   | –    |      | $I_C = 15 \text{ mA}$   |
| <b>Minimum Noise Figure</b>         |              |        |      |      |      |                         |
| Minimum noise figure                | $NF_{min}$   | –      | 0.5  | –    | dB   | $I_C = 5 \text{ mA}$    |
| Associated gain                     | $G_{ass}$    | –      | 18   | –    |      | $I_C = 5 \text{ mA}$    |
| <b>Linearity</b>                    |              |        |      |      |      |                         |
| 1 dB compression point at output    | $OP_{1dB}$   | –      | 8    | –    | dBm  | $Z_S = Z_L = 50 \Omega$ |
| 3rd order intercept point at output | $OIP3$       | –      | 25   | –    |      | $I_C = 15 \text{ mA}$   |

Table 5-8 AC Characteristics,  $V_{CE} = 2.5 \text{ V}$ ,  $f = 3.5 \text{ GHz}$ 

| Parameter                           | Symbol       | Values |      |      | Unit | Note / Test Condition   |
|-------------------------------------|--------------|--------|------|------|------|-------------------------|
|                                     |              | Min.   | Typ. | Max. |      |                         |
| <b>Power Gain</b>                   |              |        |      |      |      |                         |
| Maximum power gain                  | $G_{ma}$     | –      | 17.5 | –    | dB   | $I_C = 15 \text{ mA}$   |
| Transducer gain                     | $ S_{21} ^2$ | –      | 16   | –    |      | $I_C = 15 \text{ mA}$   |
| <b>Minimum Noise Figure</b>         |              |        |      |      |      |                         |
| Minimum noise figure                | $NF_{min}$   | –      | 0.65 | –    | dB   | $I_C = 5 \text{ mA}$    |
| Associated gain                     | $G_{ass}$    | –      | 15   | –    |      | $I_C = 5 \text{ mA}$    |
| <b>Linearity</b>                    |              |        |      |      |      |                         |
| 1 dB compression point at output    | $OP_{1dB}$   | –      | 8.5  | –    | dBm  | $Z_S = Z_L = 50 \Omega$ |
| 3rd order intercept point at output | $OIP3$       | –      | 25.5 | –    |      | $I_C = 15 \text{ mA}$   |

Table 5-9 AC Characteristics,  $V_{CE} = 2.5 \text{ V}$ ,  $f = 5.5 \text{ GHz}$ 

| Parameter                           | Symbol       | Values |      |      | Unit | Note / Test Condition   |
|-------------------------------------|--------------|--------|------|------|------|-------------------------|
|                                     |              | Min.   | Typ. | Max. |      |                         |
| <b>Power Gain</b>                   |              |        |      |      |      |                         |
| Maximum power gain                  | $G_{ma}$     | –      | 12.5 | –    | dB   | $I_C = 15 \text{ mA}$   |
| Transducer gain                     | $ S_{21} ^2$ | –      | 11.5 | –    |      | $I_C = 15 \text{ mA}$   |
| <b>Minimum Noise Figure</b>         |              |        |      |      |      |                         |
| Minimum noise figure                | $NF_{min}$   | –      | 0.85 | –    | dB   | $I_C = 5 \text{ mA}$    |
| Associated gain                     | $G_{ass}$    | –      | 10.5 | –    |      | $I_C = 5 \text{ mA}$    |
| <b>Linearity</b>                    |              |        |      |      |      |                         |
| 1 dB compression point at output    | $OP_{1dB}$   | –      | 8    | –    | dBm  | $Z_S = Z_L = 50 \Omega$ |
| 3rd order intercept point at output | $OIP3$       | –      | 24   | –    |      | $I_C = 15 \text{ mA}$   |

Note:  $OIP3$  value depends on termination of all intermodulation frequency components. Termination used for this measurement is  $50 \Omega$  from 0.2 MHz to 12 GHz.

## 5.4 Characteristic DC Diagrams

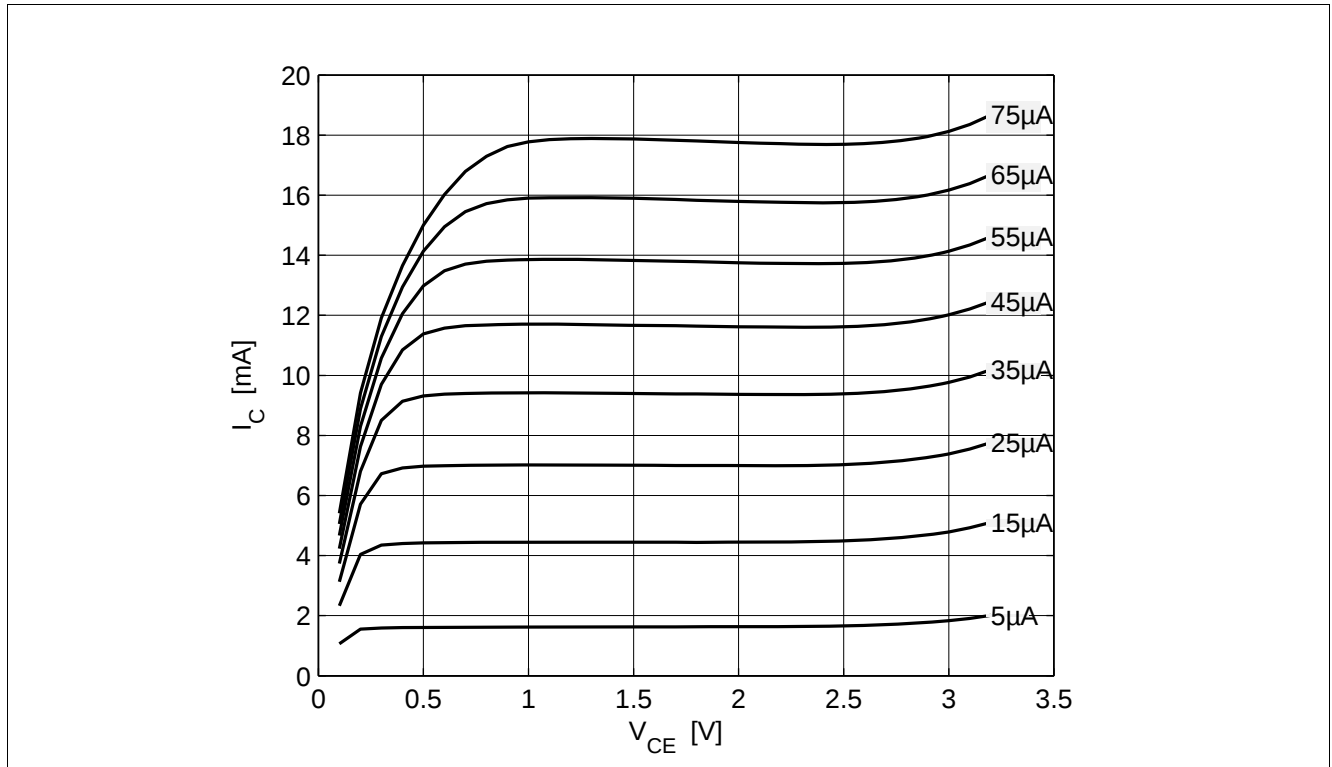


Figure 5-2 Collector Current vs. Collector Emitter Voltage  $I_C = f(V_{CE})$ ,  $I_B = \text{Parameter}$

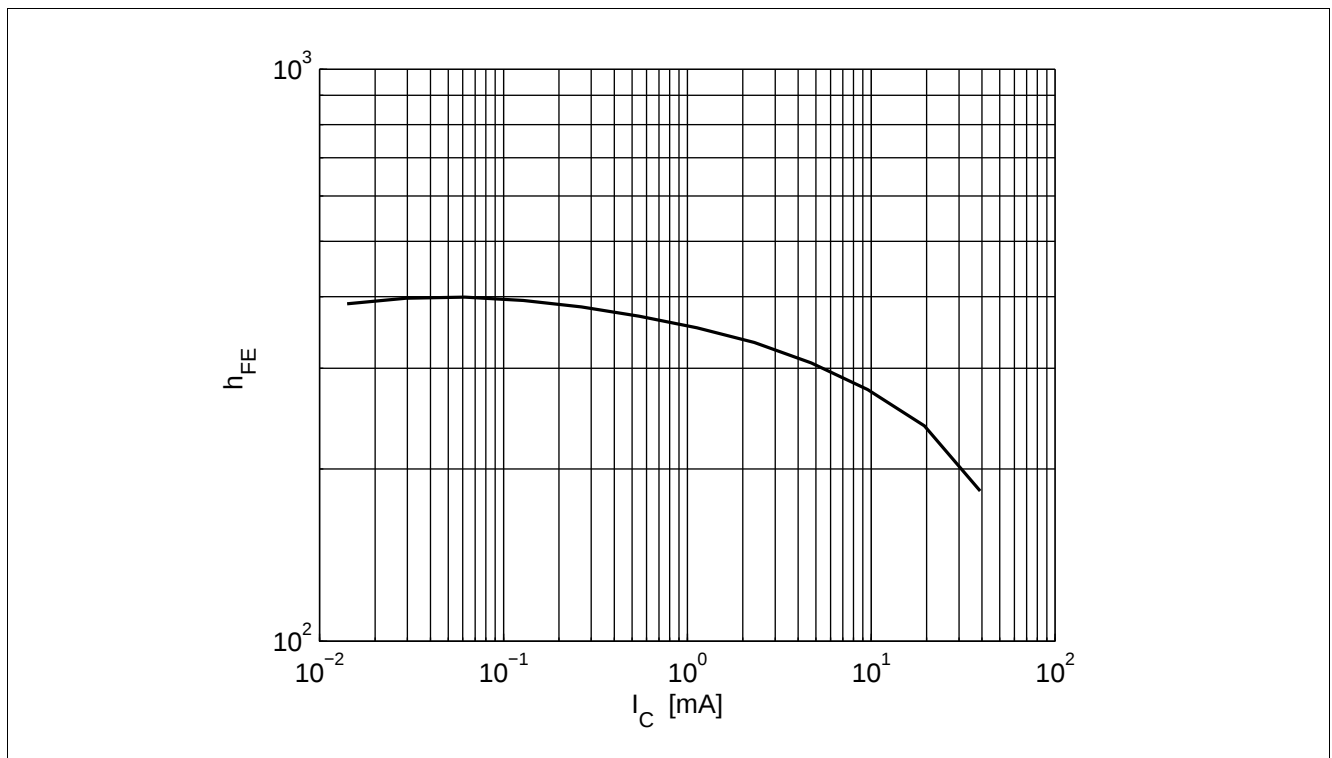


Figure 5-3 DC Current Gain  $h_{FE} = f(I_C)$ ,  $V_{CE} = 2.5 \text{ V}$

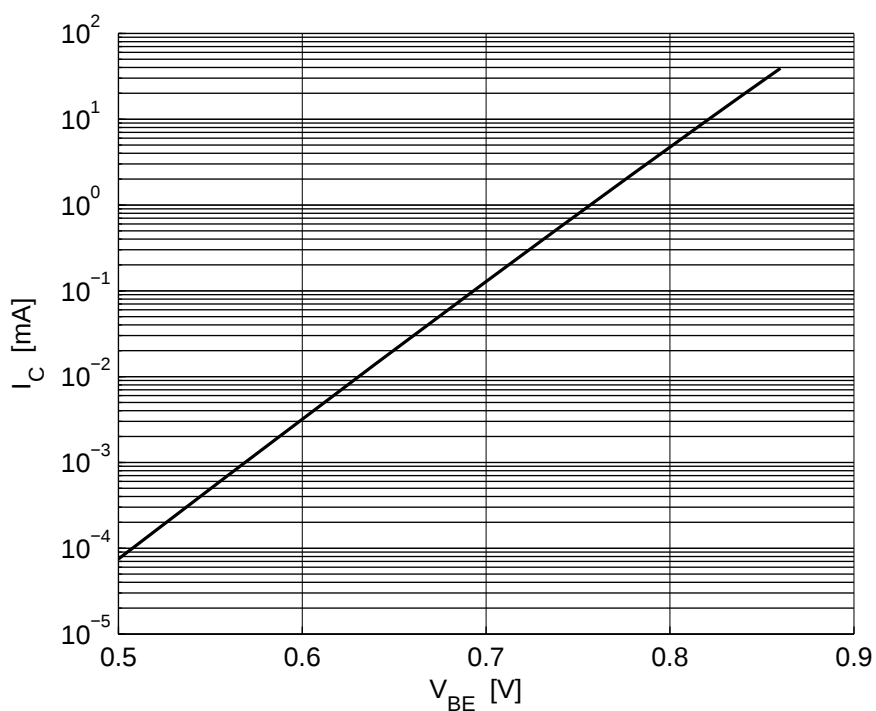


Figure 5-4 Collector Current vs. Base Emitter Forward Voltage  $I_C = f(V_{BE})$ ,  $V_{CE} = 2.5$  V

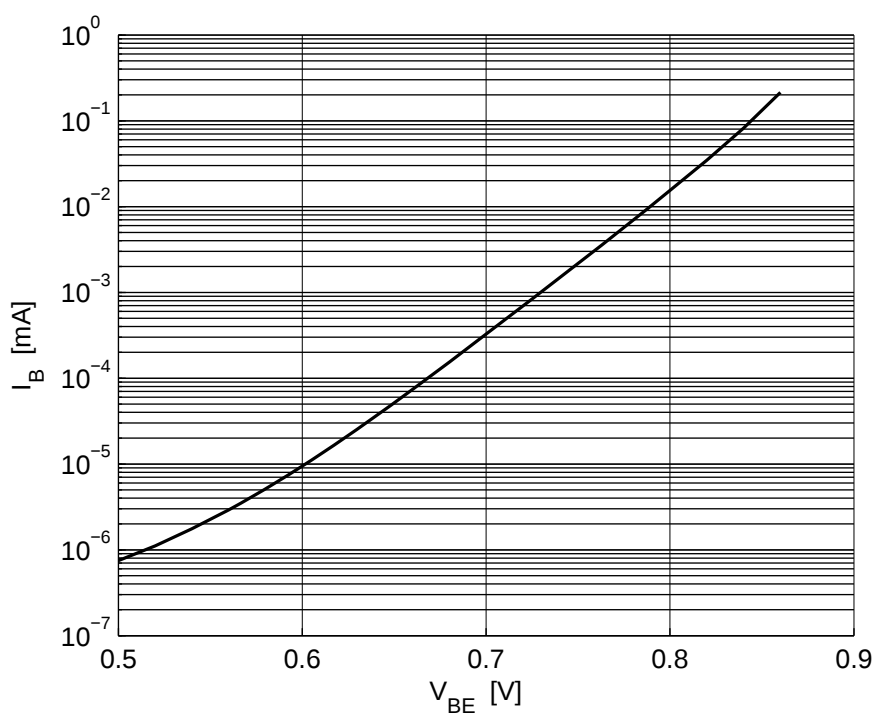


Figure 5-5 Base Current vs. Base Emitter Forward Voltage  $I_B = f(V_{BE})$ ,  $V_{CE} = 2.5$  V

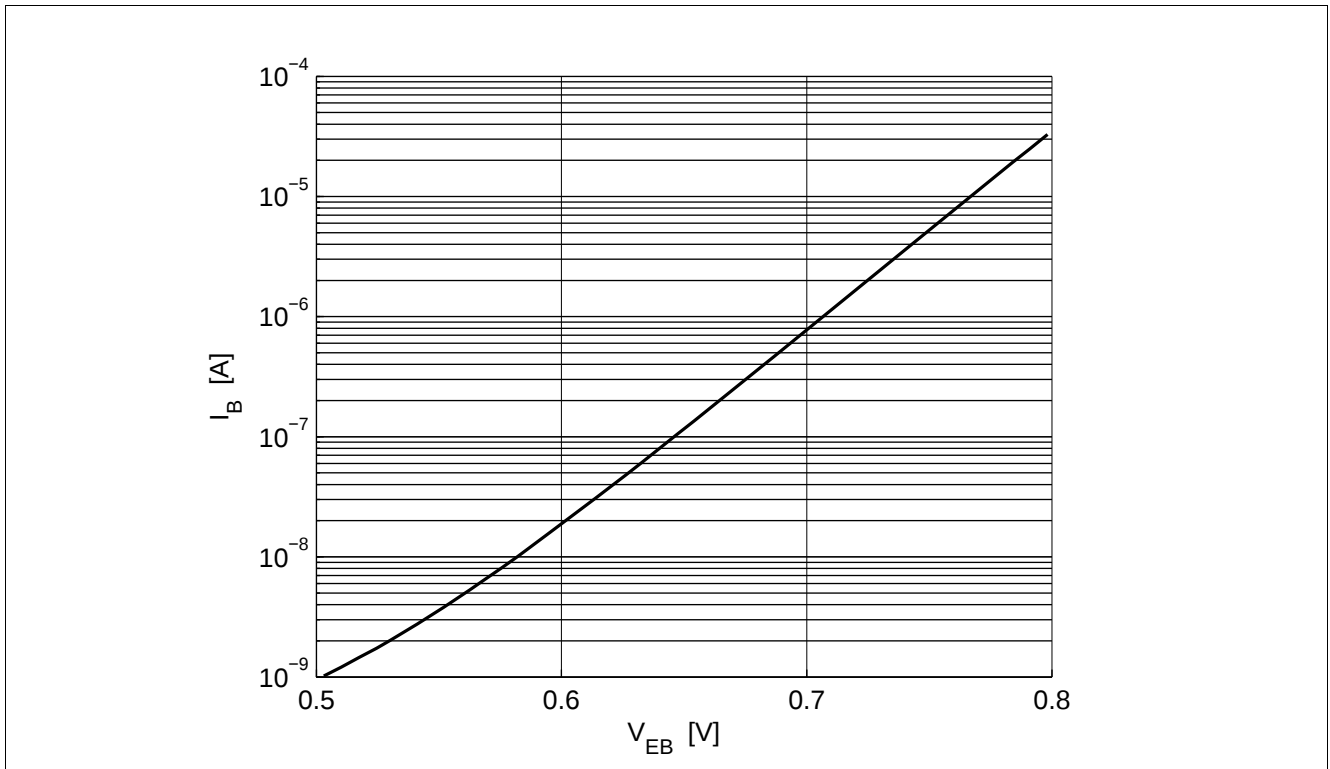


Figure 5-6 Base Current vs. Base Emitter Reverse Voltage  $I_B = f(V_{EB})$ ,  $V_{CE} = 2.5$  V

## 5.5 Characteristic AC Diagrams

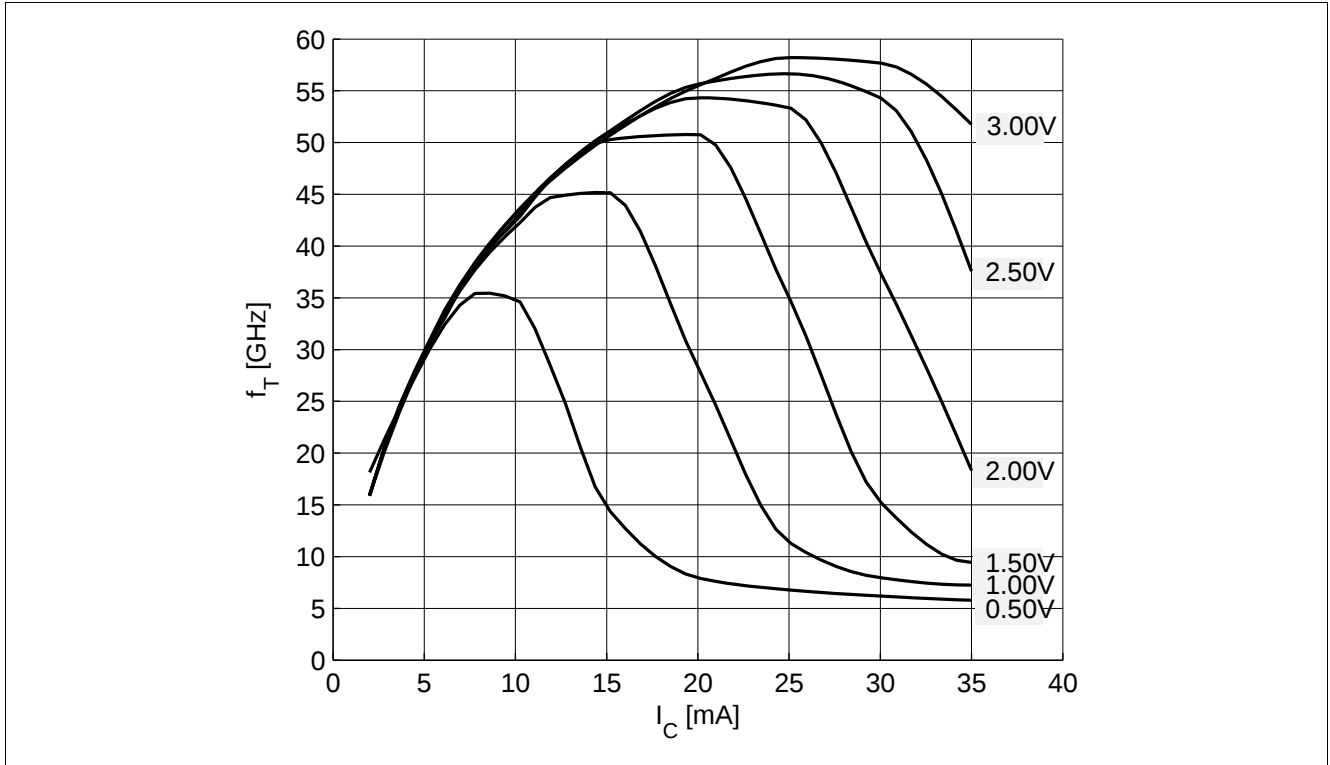


Figure 5-7 Transition Frequency  $f_T = f(I_C)$ ,  $f = 1$  GHz,  $V_{CE} = \text{Parameter}$

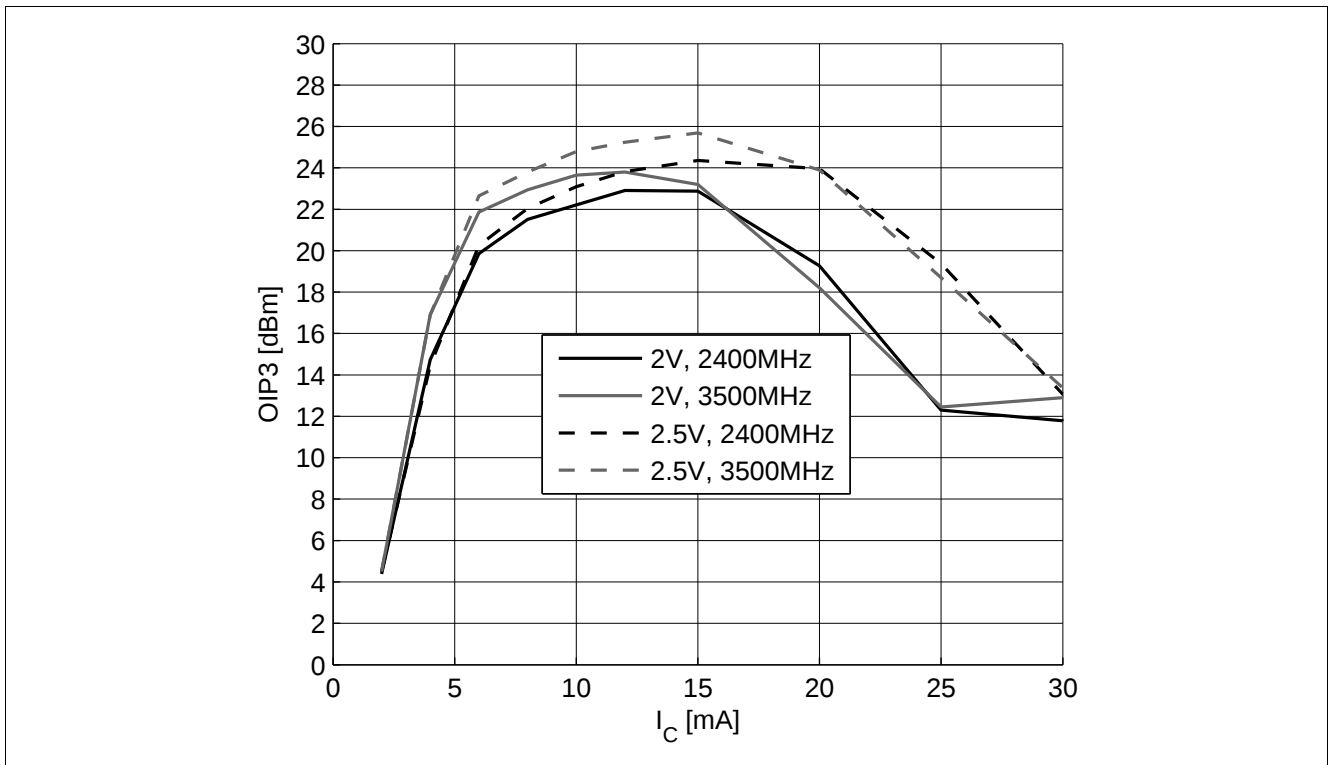


Figure 5-8 3rd Order Intercept Point at output  $OIP3 = f(I_C)$ ,  $Z_S = Z_L = 50 \Omega$ ,  $V_{CE}$ ,  $f = \text{Parameters}$

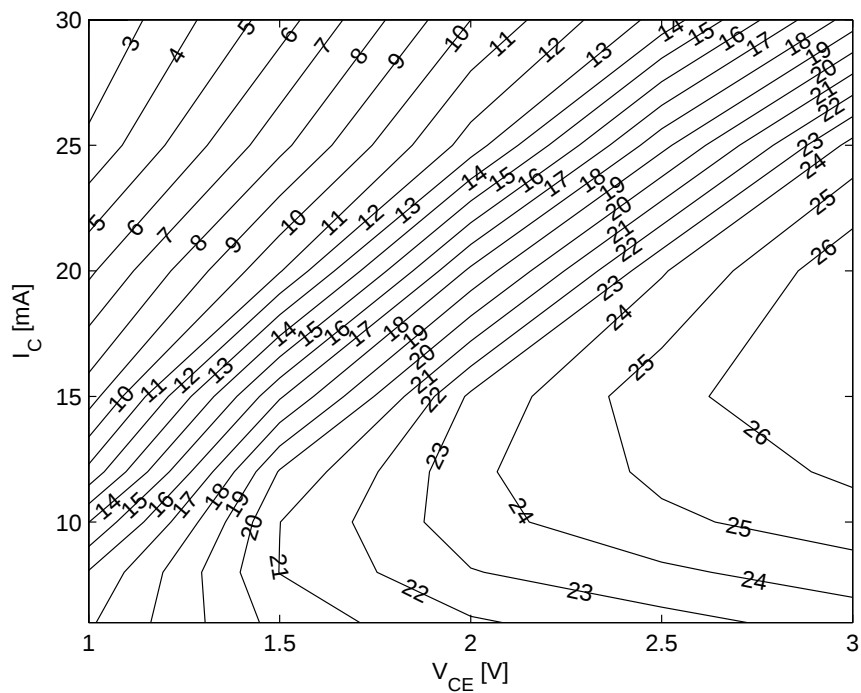


Figure 5-9 3rd Order Intercept Point at output  $OIP3 [dBm] = f(I_C, V_{CE})$ ,  $Z_S = Z_L = 50 \Omega$ ,  $f = 3.5 \text{ GHz}$

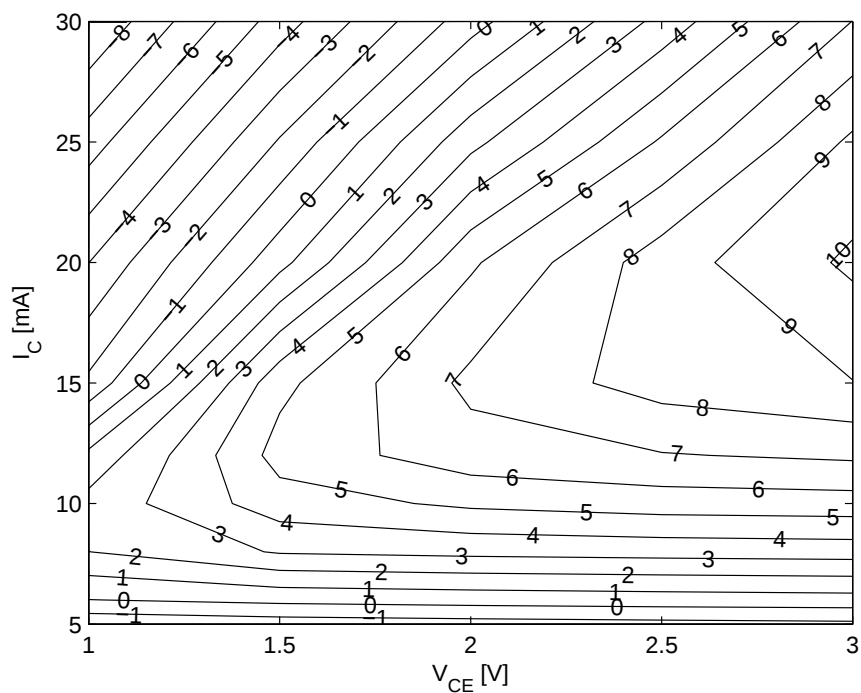


Figure 5-10 Compression Point at output  $OP_{1dB} [dBm] = f(I_C, V_{CE})$ ,  $Z_S = Z_L = 50 \Omega$ ,  $f = 3.5 \text{ GHz}$

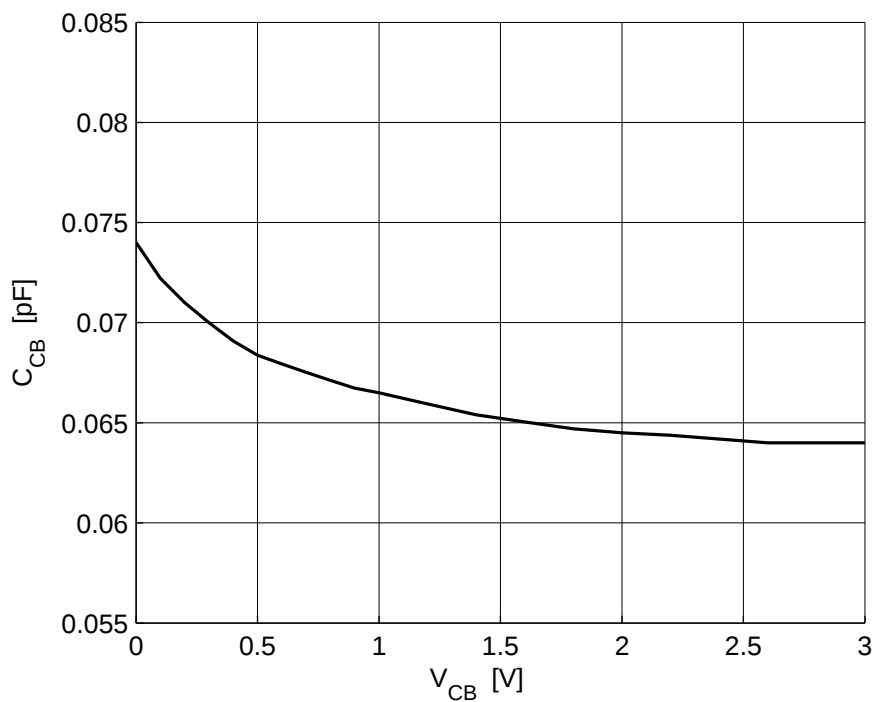


Figure 5-11 Collector Base Capacitance  $C_{CB} = f(V_{CB})$ ,  $f = 1$  MHz

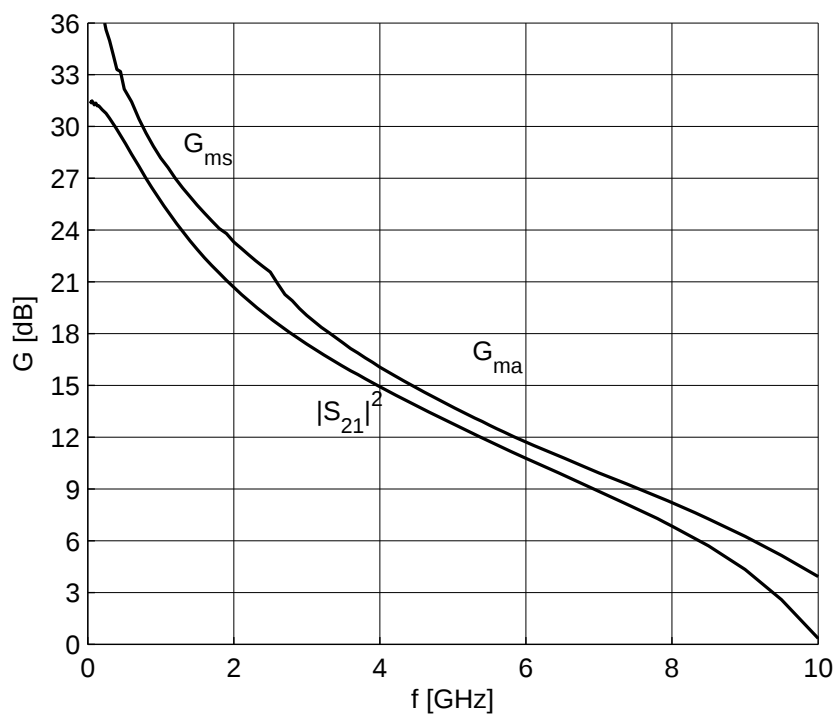


Figure 5-12 Gain  $G_{ma}$ ,  $G_{ms}$ ,  $|S_{21}|^2 = f(f)$ ,  $V_{CE} = 2.5$  V,  $I_C = 15$  mA

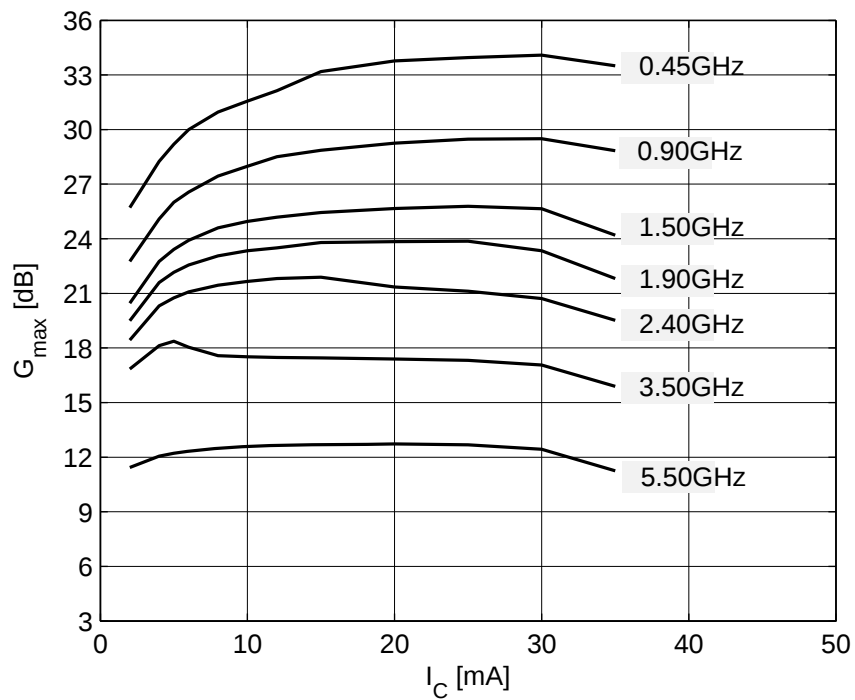


Figure 5-13 Maximum Power Gain  $G_{\max} = f(I_C)$ ,  $V_{CE} = 2.5\text{ V}$ ,  $f = \text{Parameter in GHz}$

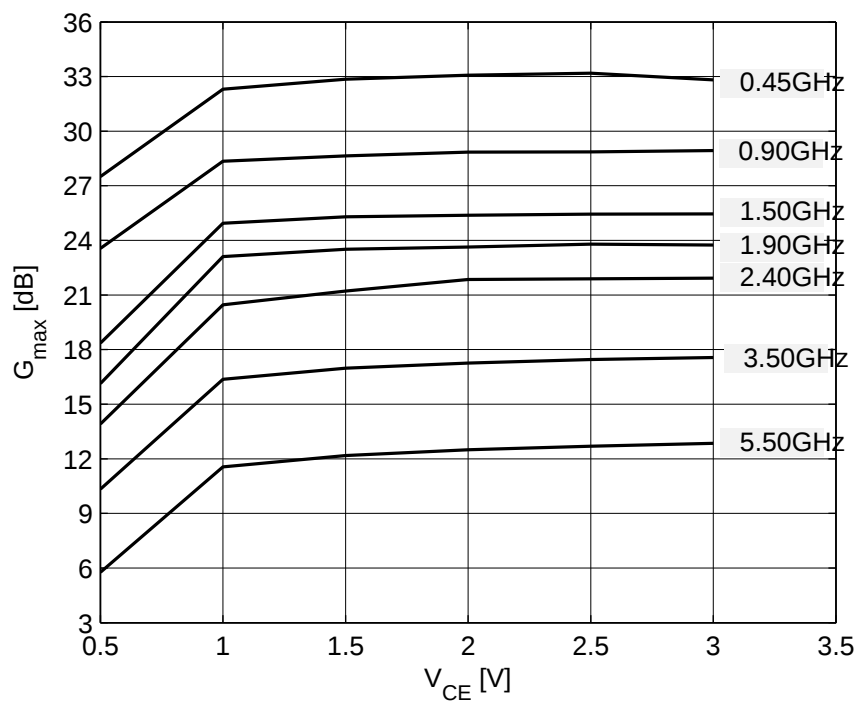


Figure 5-14 Maximum Power Gain  $G_{\max} = f(V_{CE})$ ,  $I_C = 15\text{ mA}$ ,  $f = \text{Parameter in GHz}$

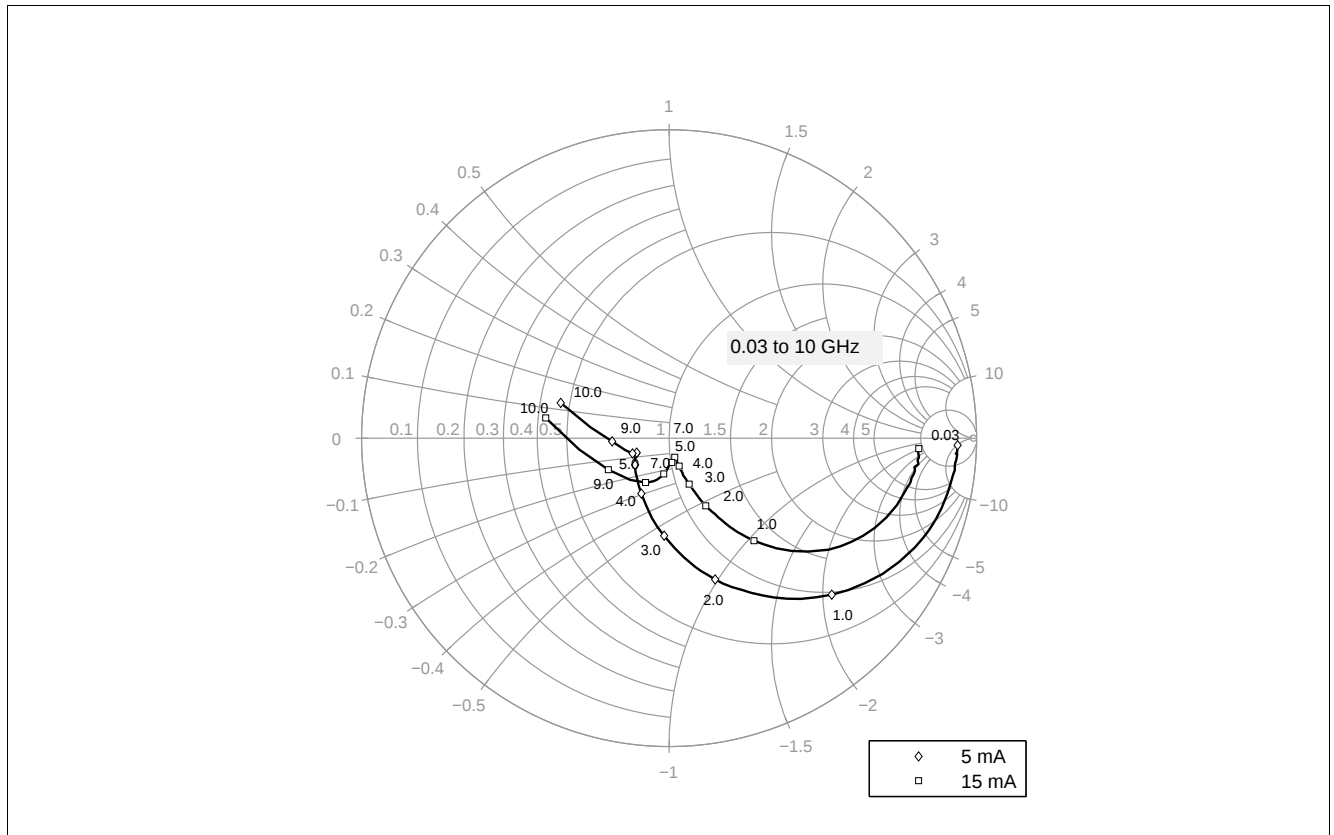


Figure 5-15 Input Reflection Coefficient  $S_{11} = f(f)$ ,  $V_{CE} = 2.5 \text{ V}$ ,  $I_C = 5 / 15 \text{ mA}$

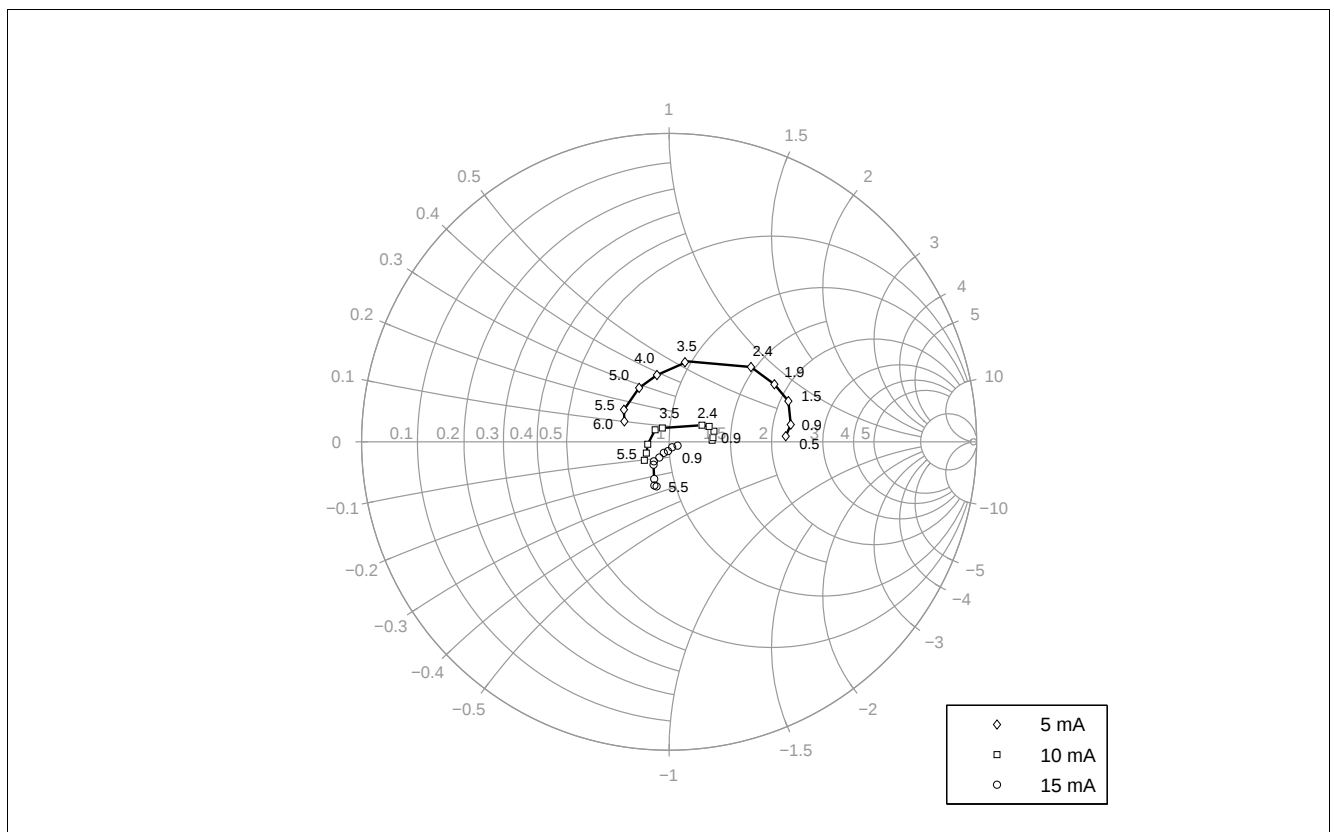


Figure 5-16 Source Impedance for Minimum Noise Figure  $Z_{opt} = f(f)$ ,  $V_{CE} = 2.5 \text{ V}$ ,  $I_C = 5 / 10 / 15 \text{ mA}$

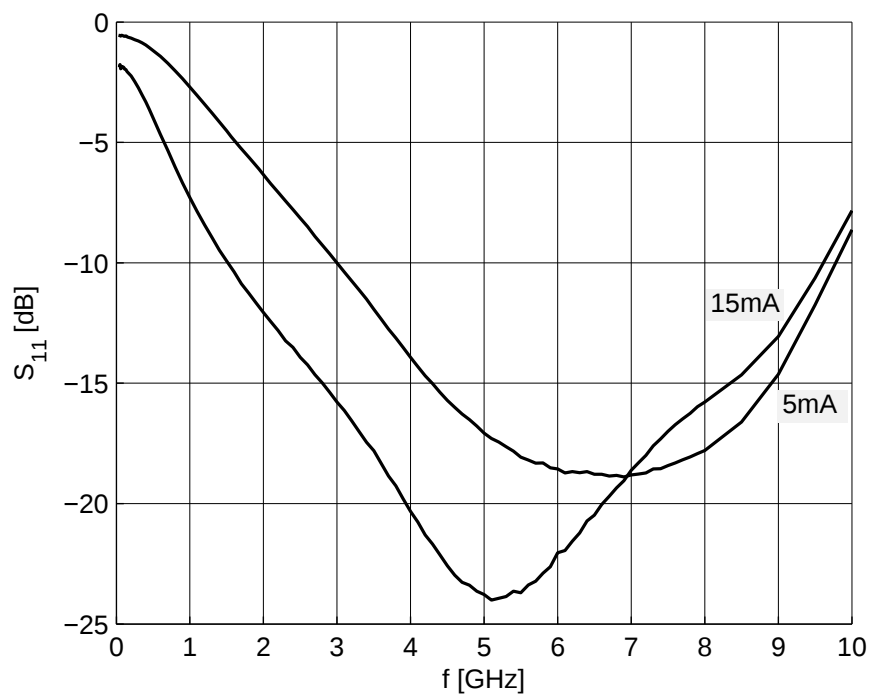


Figure 5-17 Input Reflection Coefficient  $S_{11} = f(f)$ ,  $V_{CE} = 2.5 \text{ V}$ ,  $I_C = 5 / 15 \text{ mA}$

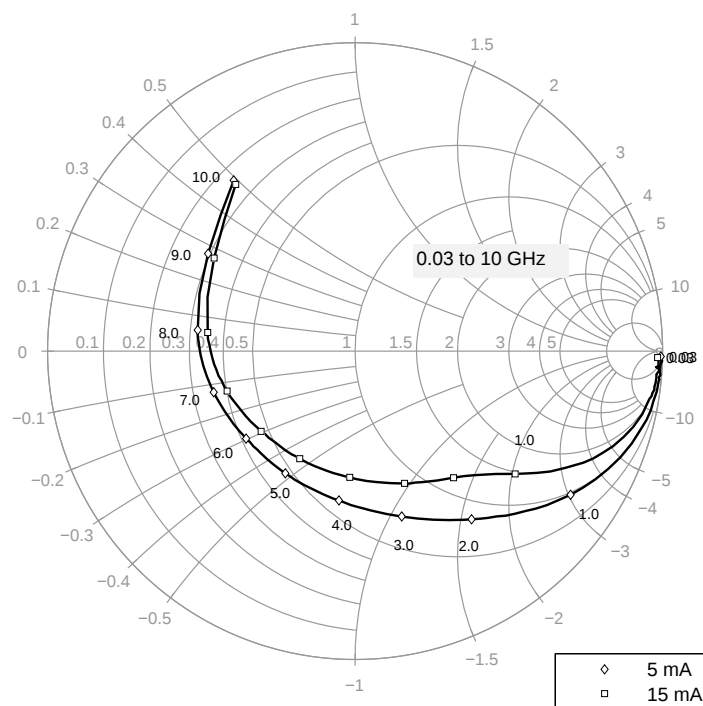


Figure 5-18 Output Reflection Coefficient  $S_{22} = f(f)$ ,  $V_{CE} = 2.5 \text{ V}$ ,  $I_C = 5 / 15 \text{ mA}$

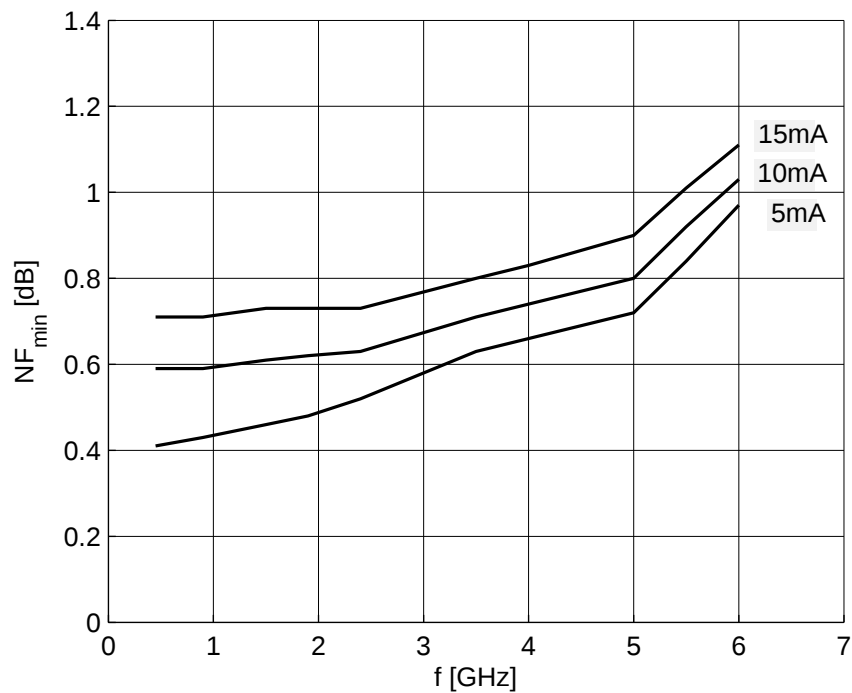


Figure 5-19 Noise Figure  $NF_{min} = f(f)$ ,  $V_{CE} = 2.5\text{ V}$ ,  $I_C = 5 / 10 / 15\text{ mA}$ ,  $Z_S = Z_{opt}$

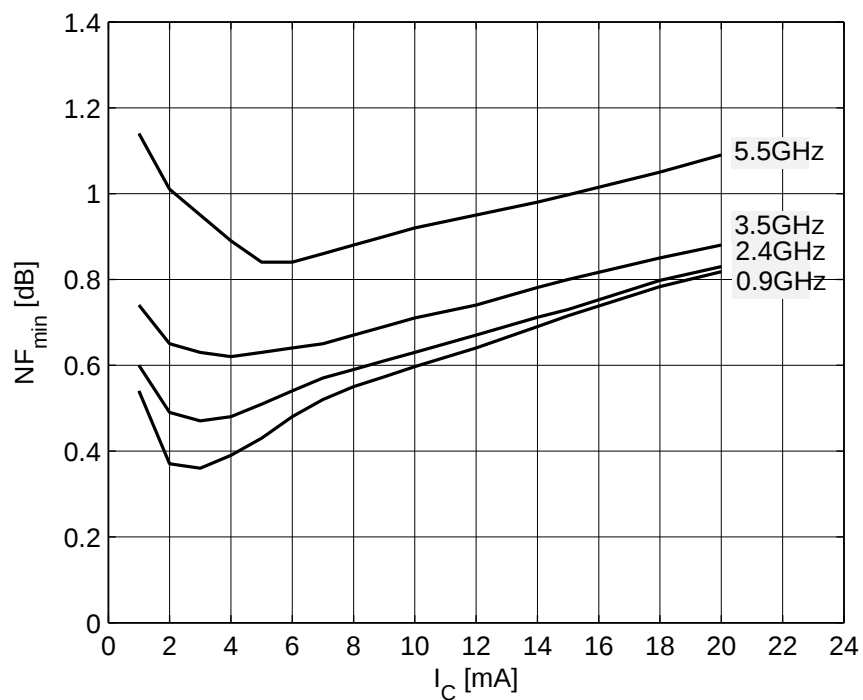
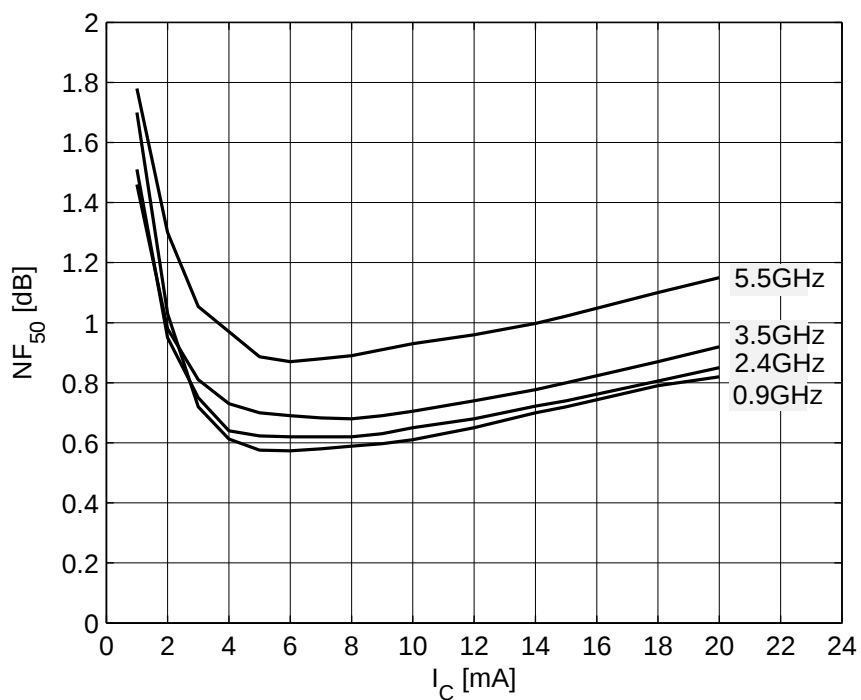


Figure 5-20 Noise Figure  $NF_{min} = f(I_C)$ ,  $V_{CE} = 2.5\text{ V}$ ,  $Z_S = Z_{opt}$ ,  $f = \text{Parameter in GHz}$



**Figure 5-21 Noise Figure  $NF_{50} = f(I_C)$ ,  $V_{CE} = 2.5\text{ V}$ ,  $Z_S = 50\ \Omega$ ,  $f = \text{Parameter in GHz}$**

*Note: The curves shown in this chapter have been generated using typical devices but shall not be considered as a guarantee that all devices have identical characteristic curves.  $T_A = 25\text{ }^\circ\text{C}$*

## 6 Simulation Data

For the SPICE Gummel Poon (GP) model as well as for the S-parameters (including noise parameters) please refer to our internet website. Please consult our website and download the latest versions before actually starting your design.

You find the BFP842ESD SPICE GP model in the internet in MWO- and ADS-format, which you can import into these circuit simulation tools very quickly and conveniently. The model already contains the package parasitics and is ready to use for DC and high frequency simulations. The terminals of the model circuit correspond to the pin configuration of the device.

The model parameters have been extracted and verified up to 12 GHz using typical devices. The BFP842ESD SPICE GP model reflects the typical DC- and RF-performance within the limitations which are given by the SPICE GP model itself. Besides the DC characteristics all S-parameters in magnitude and phase, as well as noise figure (including optimum source impedance, equivalent noise resistance and flicker noise) and intermodulation have been extracted.

## 7 Package Information SOT343

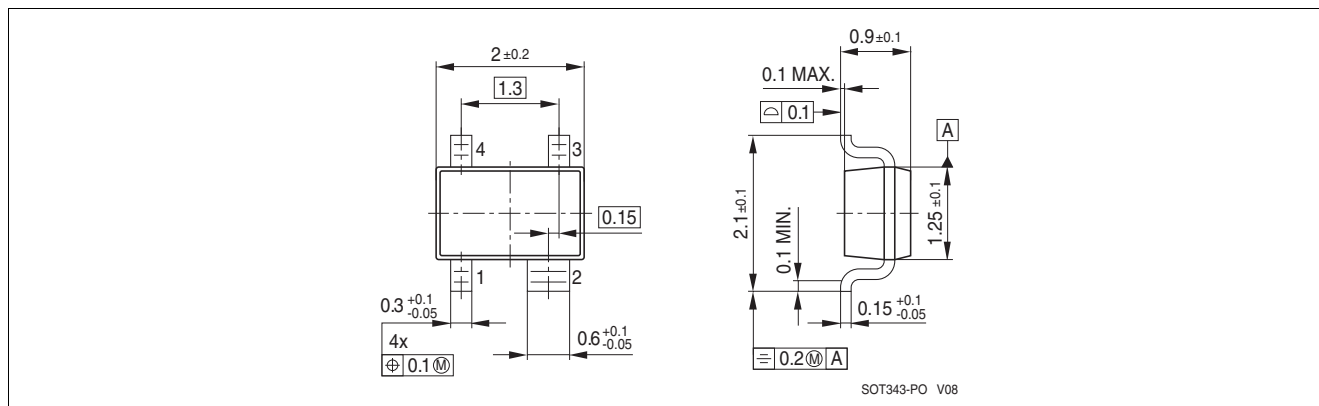


Figure 7-1 Package Outline

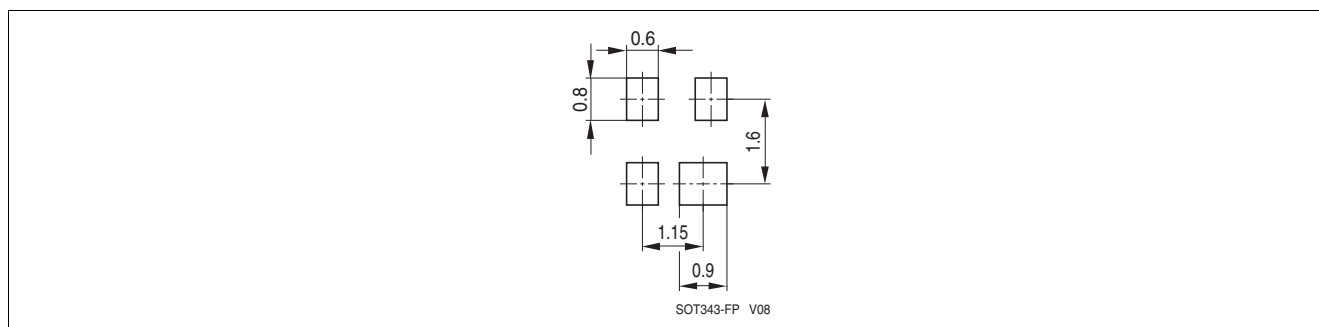


Figure 7-2 Package Footprint

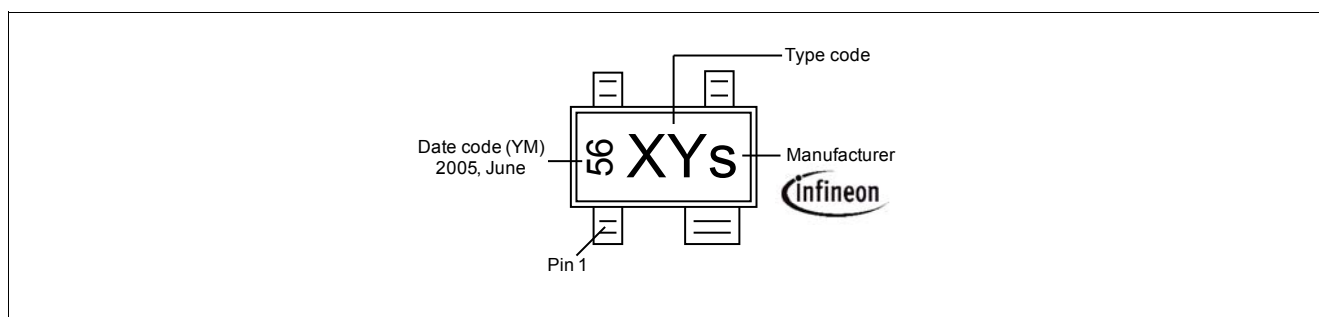


Figure 7-3 Marking Description (Marking BFP842ESD: T9s)

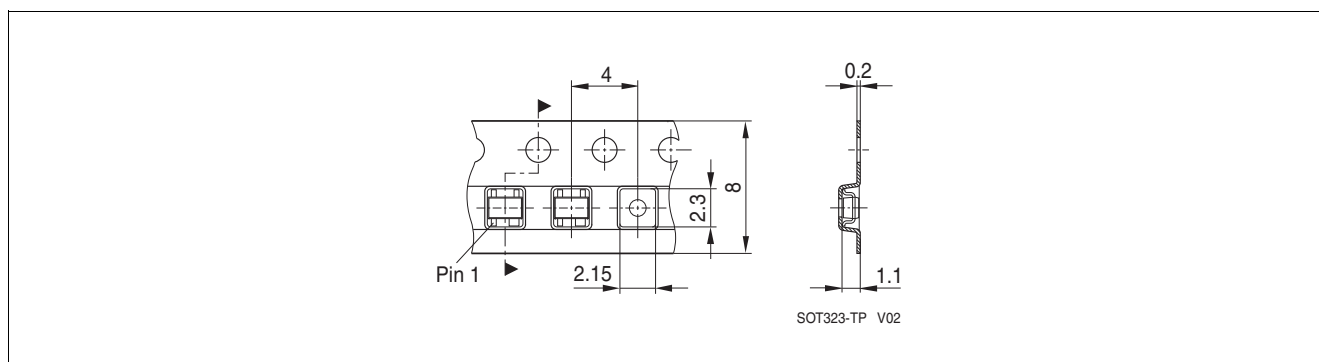


Figure 7-4 Tape dimensions

[www.infineon.com](http://www.infineon.com)

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